

MMIX1T550N055T2

TrenchT2[™] GigaMOS[™] **Power MOSFET**

(Electrically Isolated Tab)

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

Symbol	Test Conditions	Maximum Ratings			
V _{DSS}	$T_{J} = 25^{\circ}C \text{ to } 175^{\circ}C$	55	V		
V	$T_{_J}$ = 25°C to 175°C, $R_{_{GS}}$ = 1M Ω	55	V		
V _{GSM}	Transient	±20	V		
I _{D25}	T _c = 25°C (Chip Capability)	550	A		
I _{DM}	$\rm T_{\rm c}$ = 25°C, Pulse Width Limited by $\rm T_{\rm JM}$	2000	A		
I _A	$T_c = 25^{\circ}C$	200	A		
E _{AS}	$T_c = 25^{\circ}C$	3	J		
P _D	$T_c = 25^{\circ}C$	830	W		
T,		-55 +175	°C		
T		175	°C		
T _{stg}		-55 +175	°C		
Т,	1.6mm (0.062 in.) from Case for 10s	300	°C		
	Plastic Body for 10s	260	°C		
V _{ISOL}	50/60 Hz, 1 Minute	2500	٧~		
F _c	Mounting Force	50200 / 1145	N/lb.		
Weight		8	g		

Symbol (T _J = 25°C	Test Conditions C, Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.	
BV _{DSS}	$V_{gs} = 0V, I_{p} = 250 \mu A$	55			V
V _{GS(th)}	$V_{_{DS}} = V_{_{GS}}, I_{_{D}} = 250 \mu A$	1.8		3.8	V
I _{GSS}	$V_{\text{gs}} = \pm 20 \text{V}, \ V_{\text{ds}} = 0 \text{V}$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 15$	50°C		10 1.5	μA mA
R _{DS(on)}	$V_{_{\rm GS}} = 10V, I_{_{\rm D}} = 100A, Note 1$			1.3	mΩ

 $V_{\rm DSS}$ D25 = $\mathbf{R}_{\mathsf{DS(on)}}$ \leq



55V

550A

1.3mΩ

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G = Gate D = Drain S = Source

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
- Isolated Substrate
- Excellent Thermal Transfer
- Increased Temperature and Power Cycling Capability
- High Isolation Voltage (2500V~)
- 175°C Operating Temperature • Very High Current Handling
- Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Very Low R_{DS(on)}

Advantages

- · Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters and Off-Line UPS
- Primary-Side Switch
- High Speed Power Switching Applications

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Symbol	Test Conditions	Chara	racteristic Values		
$(T_{J} = 25^{\circ}C, L)$	Jnless Otherwise Specified)	Min.	Тур.	Max.	
g _{fs}	$V_{\text{DS}} = 10V, I_{\text{D}} = 60A$, Note 1	90	150	S	
C _{iss}			40	nF	
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		4970	pF	
C _{rss}			1020	pF	
R _{GI}	Gate Input Resistance		1.36	Ω	
t _{d(on)}	Resistive Switching Times		45	ns	
t _r	$V_{} = 10V_{}V_{} = 0.5 \cdot V_{} = 200A$		40	ns	
t _{d(off)}	$R_{c} = 1\Omega$ (External)		90	ns	
t _f	u · ·		230	ns	
Q _{g(on)}			595	nC	
Q _{gs}	$V_{_{\mathrm{GS}}}$ = 10V, $V_{_{\mathrm{DS}}}$ = 0.5 • $V_{_{\mathrm{DSS}}}$, $I_{_{\mathrm{D}}}$ = 0.5 • $I_{_{\mathrm{DSS}}}$		150	nC	
Q _{gd}			163	nC	
R _{thJC}				0.18 °C/W	
R _{thCS}			0.05	°C/W	

Source-Drain Diode

SymbolTest ConditionsCharac $(T_J = 25^{\circ}C, Unless Otherwise Specified)Min.$				c Value Max.	S
I _s	$V_{GS} = 0V$			550	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{JM}}$			1700	А
V _{SD}	$I_{_{\rm F}}$ = 100A, $V_{_{\rm GS}}$ = 0V, Note 1			1.2	V
$\left. \left. \begin{array}{c} t_{rr} & \\ I_{RM} & \\ Q_{RM} \end{array} \right\} ight.$	$I_F = 100A, V_{GS} = 0V$ -di/dt = 100A/ μ s $V_R = 27.5V$		100 5 250		ns A nC

Note 1. Pulse test, $t \le 300 \mu s$, duty cycle, $d \le 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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IXYS MOSFETs and IGBTs are covered	4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
by one or more of the following U.S. patents:	4,850,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,534,343	6,710,405 B2	6,759,692	7,063,975 B2	
	4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537	



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Package Outline



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SVM	INC	HES	MILLIMETERS		
SIM	MIN	MAX	MIN	MAX	
Α	.209	.224	5.30	5.70	
A1	.154	.161	3.90	4.10	
A2	.055	.063	1.40	1.60	
b	.035	.045	0.90	1.15	
С	,018	.026	0.45	0.65	
D	.976	.994	24.80	25.25	
E	.898	.915	22.80	23.25	
E1	.543	.559	13.80	14.20	
е	.07	9 BSC	2.00 BSC		
e1	.315 BSC		8.00) BSC	
Н	1.272	1.311	32.30	33.30	
L	.181	.209	4.60	5.30	
L1	.051	.067	1.30	1.70	
L2	.000	.006	0.00	0.15	
S	.736	.760	18.70	19.30	
Т	.815	.839	20.70	21.30	
\propto	0	4'	0	4'	

PIN: 1 = Gate 5-12 = Source 13-24 = Drain



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